

Electronic Patent Application Fee Transmittal

Application Number:	10754381			
Filing Date:	09-Jan-2004			
Title of Invention:	LAYERED SUPPORT AND METHOD FOR LAMINATING CMP PADS			
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Filer:	David Schnapf/Jordan Wilson			
Attorney Docket Number:	02JC-105385			
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Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Miscellaneous-Filing:				
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Patent-Appeals-and-Interference:				
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Total in USD (\$)				1000